

ENGINEERING	PRODUCT SPECIFICATION	SPEC.NO.:	SPCH032A
DEPT.	For 2.54 mm (.100") Pin Header of System CH96	PAGE:	1/3

1. SCOPE:

This specification contains the test requirement of subject pin headers when tested under the condition and below standards base on CviLux test procedure

2. APPLICABLE STANDARDS:

Methods for test of connectors for electronic equipment

Test methods for electrical connectors

MIL - STD - 202 MIL - STD - 1344 JIS - C - 5402 Methods for test of connectors for electronic equipment

UL 94 Test for flammability of plastic materials for parts in devices and

appliance

- 3. APPLICABLE SERIES NO.: CH96 SERIES
- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

(P.C. Board on which the Pin Header are installed), 1.6 mm (.063")



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		3A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max., 100 mA max.	Less than $20 \text{ m}\Omega$
7.3	Dielectric strength	When applied AC 1500 V 1minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than $1000 \text{M}\Omega$

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Push pin from insulator base at speed	More than 0.8 Kgf
		25± 3 mm per minute	

9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Solderability	Soldering time: 5 ± 0.5 second Soldering pot: 230 ± 5 °C	Minimum: 90% of immersed area
9.2	Resistance to soldering heat	Insulator: Glass filled polyester UL 94V-0 Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C Insulator: Nylon 6T Max. Infrared Reflow Soldering temperature & time: 230°C for 60 Sec. 260°C for 10 Sec.	No damage
9.3	Heat aging	105± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.5	Temperature cycling	One cycle consists of: (1)-55 +0 °C, 30 min. (2)Room temp. 10-15 min. (3) 85 -0 °C, 30 min. (4)Room temp. 10-15 min.	Appearance: No damage Contact resistance: Less than twice of initial



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9.6	Salt spray	1	Appearance: No damage Contact resistance:
			Less than twice of initial
		Measurement must be taken after water rinse	

10. AMBIENT TEMPERATURE RANGE:

-40 to + 105 °C ; + 215 °C intermittent (Vapor Phase Solder Reflow) for SMT type